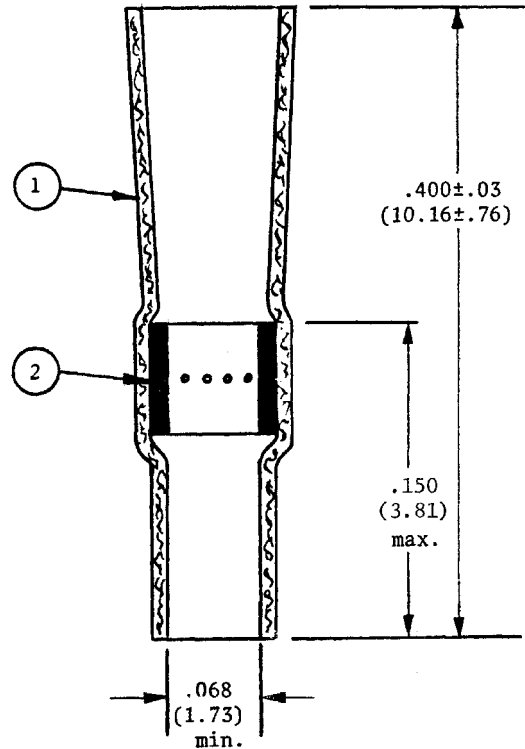


REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
A	REVISED PER ECN# T-3748	10-7-81	JS

1. INSULATION SLEEVE  
Heat shrinkable, radiation crosslinked, modified polyvinylidene fluoride, transparent blue.
2. SOLDER PREFORM WITH FLUX  
Type: Sn 63 per U.S. Federal Specification QQ-S-571.



- NOTES:
- This sleeve is designed to be used in conjunction with a Raychem AS-4000 Wire Organization System to attach tin or silver plated wires to the terminals of a Raychem SEM Type 205 Connector Wafer. Wire Range: 30 - 24 gauge. Wire Jacket O.D.: .068 maximum.
  - Sleeve will recover to .030 maximum I.D.
  - Acceptance sampling shall be in accordance with Inspection Level I of MIL-STD-105. The acceptable quality level (AQL) shall be 4.0.

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Check with the web for latest revision.

DO NOT SCALE THIS DRAWING		CONNECTORS SPECIFICATION CONTROL DRAWING		© 1978 RAYCHEM CORPORATION	
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND TOLERANCES ARE: .XXX: ± .XX: ± .X: ±	DRAWN	GAS 1-25-72		RAYCHEM	
	CHECKED	<i>[Signature]</i>			
	APPROVED	BY A. J. S-14		TITLE	
MATERIAL	APPROVED	SET 10/31/78		Solder Sleeve Wire Terminator, SEM Wafer Wire Range: 30 - 24	
	APPROVED				
FINISH	PART NO.		SIZE	CODE IDENT.	DWG. NO.
	PROJECT	6448-7029	A	NO. 06090	CTA-0050-01
		SCALE	WEIGHT		SHEET 1 OF 1